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APPLICATION NO.		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.		
10/721,110		11/24/2003	Chad A. Cobbley	2269-3437.9US (97-0514.09	6106		
24247	7590	09/07/2004		EXAM	EXAMINER		
TRASK BR P.O. BOX 2:			KOBERT, RUS	KOBERT, RUSSELL MARC			
SALT LAKE CITY, UT 84110				ART UNIT	PAPER NUMBER		
				2829			

DATE MAILED: 09/07/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application	on No.	Applicant(s)					
		10/721,11		COBBLEY ET AL.					
Of	fice Action Summary	Examiner		Art Unit					
	-	Russell M	Kohert	2829					
The f	MAILING DATE of this communication				dress				
Period for Repl				•					
THE MAILIN - Extensions of t after SIX (6) M - If the period for - If NO period for - Failure to reply Any reply recei	NED STATUTORY PERIOD FOR R IG DATE OF THIS COMMUNICATION of the may be available under the provisions of 37 CONTHS from the mailing date of this communication reply specified above is less than thirty (30) days, or reply is specified above, the maximum statutory provided by the office later than three months after the term adjustment. See 37 CFR 1.704(b).	ON. FR 1.136(a). In no even on. a reply within the statueriod will apply and wistatute, cause the appl	ent, however, may a reply be tim story minimum of thirty (30) days Il expire SIX (6) MONTHS from t ication to become ABANDONE	ely filed s will be considered timely. the mailing date of this cor 0 (35 U.S.C. § 133).					
Status									
1)⊠ Respo	nsive to communication(s) filed on	28 July 2004.							
· ·	This action is FINAL . 2b) This action is non-final.								
3) Since	3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is								
closed	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.								
Disposition of 0	Claims								
4)⊠ Claim((s) <u>1-18</u> is/are pending in the applica	ation.							
•	4a) Of the above claim(s) <u>3-12</u> is/are withdrawn from consideration.								
5) Claim(s) is/are allowed.									
6)⊠ Claim(6)⊠ Claim(s) <u>1,2,13 and 16-18</u> is/are rejected.								
7)⊠ Claim(7) Claim(s) 14 and 15 is/are objected to.								
8)☐ Claim((s) are subject to restriction a	and/or election re	equirement.						
Application Pag	pers								
9)∐ The sp	ecification is objected to by the Exa	miner.							
10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.									
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).									
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).									
11)∐ The oa	th or declaration is objected to by the	ne Examiner. No	te the attached Office	Action or form PT0	O-152.				
Priority under 3	35 U.S.C. § 119								
12) ☐ Acknow	wledgment is made of a claim for fo	reign priority und	der 35 U.S.C. § 119(a)	-(d) or (f).					
•	b) ☐ Some * c) ☐ None of:		,	, , , ,	•				
1. Certified copies of the priority documents have been received.									
2.	Certified copies of the priority docu	ments have bee	n received in Application	on No					
	Copies of the certified copies of the	•		d in this National S	Stage				
	application from the International B	,	, ,,						
* See the	attached detailed Office action for	a list of the certi	tied copies not receive	a.					
Attachment(s)			_						
	erences Cited (PTO-892) tsperson's Patent Drawing Review (PTO-94	Ω\	4) Interview Summary Paper No(s)/Mail Da						
3) 🛛 Information D	isperson's Patent Drawing Review (P10-94 isclosure Statement(s) (PTO-1449 or PTO/S fail Date 1103, 0304 & 0604			atent Application (PTO	-152)				

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1. Applicant's election without traverse of Species (a), claims 1, 2 and 13-18 in the reply filed on July 28, 2004 is acknowledged.

- 2. Claims 3-12 are withdrawn from further consideration pursuant to 37 CFR 1.142(b) as being drawn to a nonelected Species, there being no allowable generic or linking claim. Election was made **without** traverse in the reply filed on July 28, 2004.
- 3. Claims 14 and 15 are objected to as being dependent on non-existing claims 23 and 24 and thus have not been considered.
- 4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 5. Claims 1, 2, 13, 16-18 are rejected under 35 U.S.C. 102(b) as being anticipated by Hembree et al (5424652).

Hembree et al anticipates a method for electrically testing a flip-chip semiconductor assembly formed from at least one integrated circuit (IC) die (24) and a substrate (14), the method comprising:

Contacting the substrate with probes (26);

While the substrate is in contact with the probes, bringing the at least one die and the substrate together (via metal clips 34) in conductive contact to form the flip-chip semiconductor assembly; and

Before the at least one die is sealed, electrically testing the assembly using the probes (col 5, ln 19-47); as recited in claim 1.

As to claim 2, having a die-attach station is anticipated by Hembree et al (all of Figure 1 is considered a die-attach station).

As to claim 13, having the bond pads on a surface of the die in a cur<u>able</u> conductive contact with conductive pads on the surface of the substrate is considered inherent to Hembree et al.

As to claim 16, the act of bringing the at least one IC die and the substrate together comprises flip-chip attaching (col 4, In 65-67; col 5, In 48-51) the at least one IC die to the substrate is anticipated by Hembree et al.

As to claim 17, reworking the flip-chip semiconductor assembly and retesting the flip-chip semiconductor assembly if the flip-chip semiconductor assembly fails the electrical testing act is anticipated by Hembree et al (Hembree et al discusses "re-work"; see col 1, ln 62-68).

As to claim 18, curing the curable conductive contact if the flip-chip semiconductor assembly passes the electrical testing act is considered inherent to Hembree et al (Hembree et al discusses "packaging" only known good die that can only be accomplished in the alternative to "poor wire bonds, cracked packages and improper die attachments"; see col 5, In 31-40)

6. A shortened statutory period for response to this action is set to expire three month(s) from the date of this letter. Failure to respond within the period for response will cause the application to become abandoned. 35 U.S.C. 133

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Russell Kobert whose telephone number is (571) 272-1963. The Examiner's Supervisor, Michael J. Tokar, can be reached at (571) 272-1812. For an automated menu of Tech Center 2800 phone numbers call (571) 272-2800.

Russell M. Kobert Patent Examiner Group Art Unit 2829 August 27, 2004

Michael Tokar
Supervisory Patent Examiner
Technology Center 2800

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